

AP1608P1C

1.6 x 0.8 mm Phototransistor



DESCRIPTION

· Made with silicon phototransistor chips

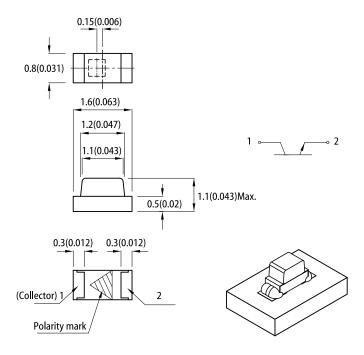
FEATURES

- 1.6 mm x 0.8 mm SMD LED, 1.1 mm thickness
- · Mechanically and spectrally matched to infrared emitting LED lamp
- Package matched with IR emitter AP1608F3C
- · Water clear lens
- Package: 2000 pcs / reel
- Moisture sensitivity level: 3
- Halogen-free
- RoHS compliant

APPLICATIONS

- · Infrared applied systems
- Optoelectronic switches
- · Photodetector control circuits
- Sensor technology

PACKAGE DIMENSIONS



RECOMMENDED SOLDERING PATTERN

(units: mm; tolerance: \pm 0.1)



- 1. All dimensions are in millimeters (inches). 2. Tolerance is +0.1/0.004" vert
- 2. Tolerance is ±0.1(0.004") unless otherwise noted.
 3. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.

 4. The device has a single mounting surface. The device must be mounted according to the specifications.

ABSOLUTE MAXIMUM RATINGS at T_A=25°C

| Parameter | Max.Ratings | Units |
|--|-------------|-------|
| Collector-to-Emitter Voltage | 30 | V |
| Emitter-to-Collector Voltage | 5 | V |
| Power Dissipation at(or below) 25°C Free Air Temperature | 100 | mW |
| Operating Temperature | -40 to +85 | °C |
| Storage Temperature | -40 to +85 | °C |

Note:
1. Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity – Ref JEDEC/JESD625-A and JEDEC/J-STD-033.

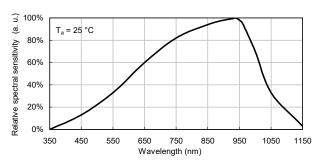


ELECTRICAL / OPTICAL CHARACTERISTICS at T_A=25°C

| Parameter | Symbol | Min. | Тур. | Max. | Units | Test Conditions |
|---|-----------------------|------|------|------|-------|--|
| Collector-to-Emitter Breakdown Voltage | V _{BR CEO} | 30 | - | - | V | $I_C = 100\mu A$ $E_e = 0 \text{mW/cm}^2$ |
| Emitter-to-Collector Breakdown Voltage | V _{BR ECO} | 5 | - | - | V | $I_E = 100 \mu A$ $E_e = 0 mW/cm^2$ |
| Collector-to-Emitter Saturation Voltage | V _{CE (SAT)} | - | - | 0.8 | V | $I_C = 2mA$ $E_e = 20mW/cm^2$ |
| Collector Dark Current | I _{CEO} | - | - | 100 | nA | V _{CE} = 10V E _e = 0mW/cm ² |
| Rise Time(10% to 90%) | t _r | - | 15 | - | μS | $V_{CE} = 5V$ $I_{C} = 1mA$ $R_{L} = 1000\Omega$ |
| Fall Time(90% to 10%) | t _f | - | 15 | - | μS | |
| On State Collector Current | I _(ON) | 0.1 | 0.3 | - | mA | $V_{CE} = 5V$ $E_e = 1 \text{mW/cm}^2$ $\lambda = 940 \text{nm}$ |
| Range of Spectral Bandwidth | λ _{0.1} | 420 | - | 1120 | nm | - |
| Wavelength of Peak Sensitivity | λ_{p} | - | 940 | - | nm | - |

TECHNICAL DATA

RELATIVE SPECTRAL SENSITIVITY vs. WAVELENGTH

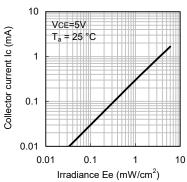




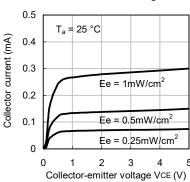
TECHNICAL DATA

PHOTOTRANSISTOR

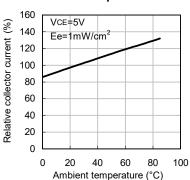
Collector Current vs. Irradiance



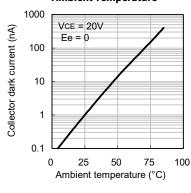
Collector Current vs. **Collector-Emitter Voltage**



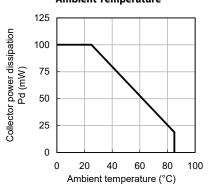
Relative Collector Current vs. **Ambient Temperature**



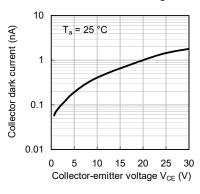
Collector Dark Current vs. **Ambient Temperature**



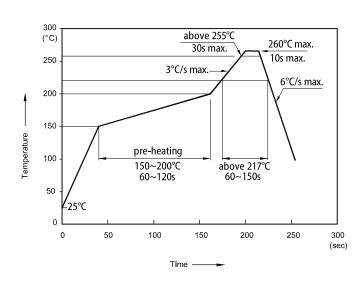
Collector Power Dissipation vs. **Ambient Temperature**



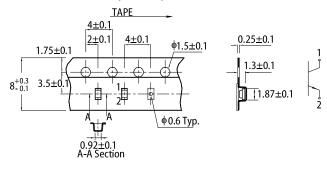
Collector Dark Current vs. **Collector-Emitter Voltage**



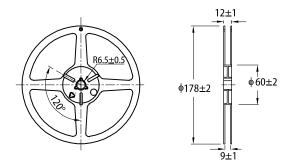
REFLOW SOLDERING PROFILE for LEAD-FREE SMD PROCESS



TAPE SPECIFICATIONS (units:mm)



REEL DIMENSION (units: mm)



- Notes.

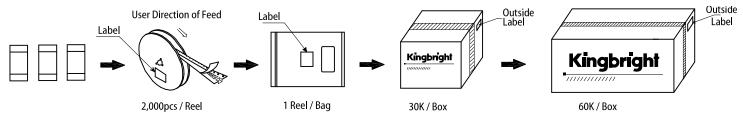
 1. Don't cause stress to the LEDs while it is exposed to high temperature.

 2. The maximum number of reflow soldering passes is 2 times.

 3. Reflow soldering is recommended. Other soldering methods are not recommended as they might



PACKING & LABEL SPECIFICATIONS





PRECAUTIONARY NOTES

- The information included in this document reflects representative usage scenarios and is intended for technical reference only.
- The part number, type, and specifications mentioned in this document are subject to future change and improvement without notice. Before production usage customer should refer to the latest datasheet for the updated specifications.
- When using the products referenced in this document, please make sure the product is being operated within the environmental and electrical limits specified in the datasheet. If customer usage exceeds the specified limits, Kingbright will not be responsible for any subsequent issues.

 The information in this document applies to typical usage in consumer electronics applications. If customer's application has special reliability requirements or have life-threatening liabilities, such as automotive or medical usage, please consult with Kingbright representative for further assistance.

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